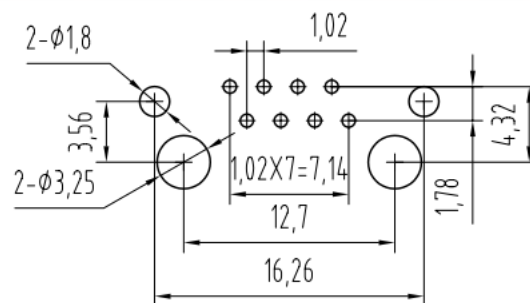
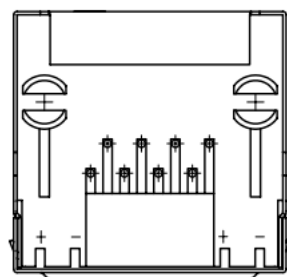
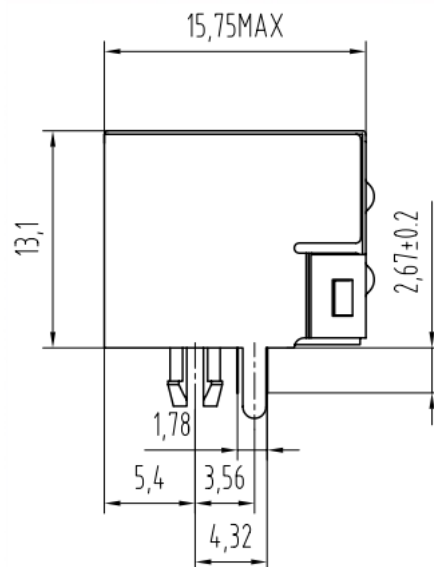
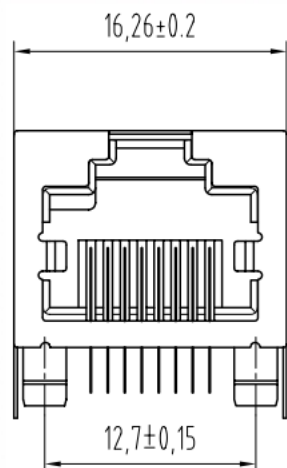


REVISION RECORD				
REV	ECO	DESCRIPTION	RFT	CHKD



PC Board Layout
Component Side Shown

NOTES:

MATERIAL :

- 1.HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
- 2.CONTACT MATERIAL : PHOSPHOR BRONZE $\phi 0.46\text{mm}$.
- 3.PLATING : GOLD PLATING OVER NICKEL.
- 4.SHIELD : $\phi 0.23\text{mm}$ THICKNESS COPPER ALLOY WITH NICKEL PLATED.

ELECTRICAL:

- 1.VOLTAGE RATING : 125 VAC RMS.
- 2.CURRENT RATING : 1.5 AMP.
- 3.CONTACT RESISTANCE : 30 MILLIOHMS MAX.
- 4.INSULATION RESISTANCE : 500 MEGOHMS MIN @ 50 V DC .
- 5.DIELECTRIC WITHSTANDING RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

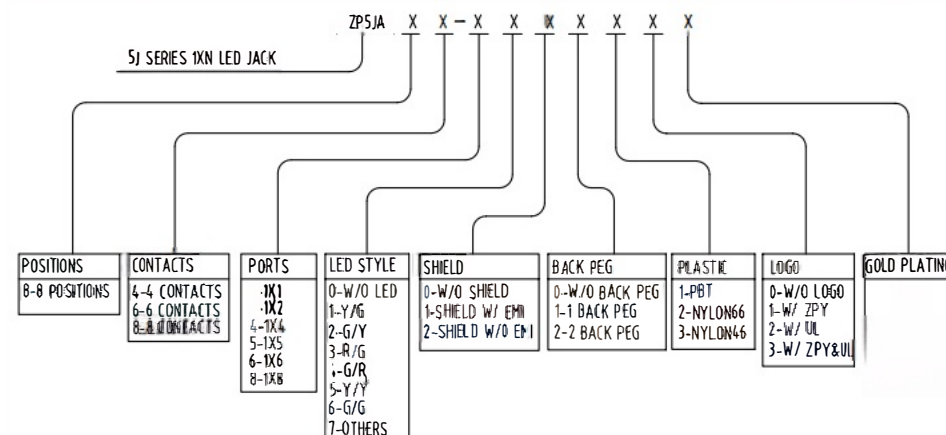
MECHANICAL:

- 1.DURRABILITY : 750 CYCLES MIN.
- 2.PCB RETENTION PRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$
2. OPERATION : 0°C TO 70°C .

PART NUMBER:



TOLERANCES EXCEPT AS NOTED MM .05 ± 0.05 .05 ± 0.05 .05 ± 0.05		DATE 2007.05.05 DATE DATE DATE		浙江创都电子科技有限公司 RJ56-8P8C-WLQB	
ANGLES ± 0.5 THIRD ANGLE PROJECTION		MATERIAL : QTY : FINISH : SCALE :			
DETACHED LISTS		DRAWING NO. TESJA100 PART NO.			
DO NOT SCALE DRAWING		SHEET X OF Y			